



Attorney's Docket No.: 07977/242001/US3586

PATENT

#10/A
10
11/11/00

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Hideto Ohnuma, et al. Art Unit : 1765
Serial No. : 09/050,182 Examiner : Kunemund, R.
Filed : March 26, 1998
Title : METHOD OF MANUFACTURING A SEMICONDUCTOR DEVICE

Assistant Commissioner for Patents
Washington, D.C. 20231

AMENDMENT

Sir:

In response to the Official Action dated July 16, 1999,
paper no. 8, in the above-referenced case, kindly amend the
above-referenced application as follows:

IN THE CLAIMS:

Please amend the claims as follows:

A150
1. (Amended) A method of manufacturing a semiconductor
device, comprising:

11/24/1999 AIBRAHIM 00000008 09050182

01 FC:103
02 FC:102
03 FC:104
04 FC:115

1728.00 OP
234.00 OP
260.00 OP
110.00 OP

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